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JC962 U.S. PTO

PATENT APPLICATION
Attorney's Do. No. 9109-33

Jc872 U.S. PTO
10/016578
11/01/01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

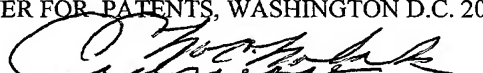
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I HEREBY CERTIFY THAT THIS PAPER AND ENCLOSURES AND/OR FEE ARE BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE" SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED ABOVE AND IS ADDRESSED TO: BOX PATENT APPLICATION, ASSISTANT COMMISSIONER FOR PATENTS, WASHINGTON D.C. 20231.

ADRIENNE CHOCHOLAK
(SENDER'S PRINTED NAME)


(SIGNATURE)

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventors: JAMES D. PARSONS and B. LEO KWAK

For: ADHESION AND/OR ENCAPSULATION OF SILICON CARBIDE-BASED SEMICONDUCTOR DEVICES ON CERAMIC SUBSTRATES

Related Application Data

This application is a divisional of copending U.S. Patent Application Serial No. 09/351,106, filed July 6, 1999, now U.S. Patent No. 6,319,757, to issue November 20, 2001, which claims priority from U.S. Provisional Application Serial No. 60/092,039, filed July 8, 1998.

Prior application info: Examiner: C. Lytle Group Art Unit 2825

Applicant requests FIG.2 to be published with the application.

Enclosures:

- ☒ Specification (pages 1-16); claims (pages 17-18); abstract (page 19)
- ☒ 1 sheet of drawings
- ☒ Combined Declaration and Power of Attorney with Added Page signed by Assignee on behalf of non-signing Inventors in 09/351,106
- ☒ Copy from a prior application (37 CFR 1.63(d)) 09/351,106

- ☒ Decision According Status Under 37 C.F.R. 1.47(b) in 09/351,106
- ☒ Incorporation by Reference--The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference
- ☒ Copy of Recorded Assignments in parent application 09/351,106 and name change document from 3C Semiconductor Corporation to Caldus Semiconductor, Inc. previously submitted for recordal

Assignee Name and Address:

Caldus Semiconductor, Inc., an Oregon corporation
1356 Parkview Ct. NE
Keizer, OR 97303-7218

- ☒ Information Disclosure Statement with Form PTO 1449
- ☒ Applicant claims small entity status (see 37 CFR 1.27)

CLAIMS AS FILED				
For	Number Filed	Number Extra	Rate	Basic Fee \$370
Total Claims	12-20	0	x \$ 9 =	0
Independent Claims	4-3	1	x \$ 42 =	42
TOTAL FILING FEE				\$412

- ☒ PTO Form 2038 authorizing credit card payment for the above-listed fees is enclosed.
- ☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A duplicate copy of this sheet is enclosed.

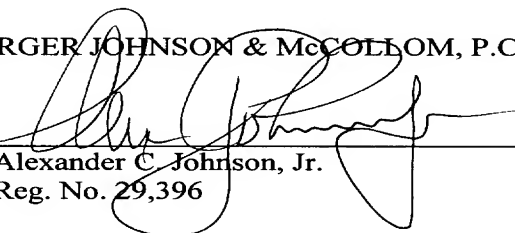


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Respectfully submitted,

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